

HD74LS11 / HD74LS15

Triple 3-input Positive AND Gates /
Triple 3-input Positive AND Gates (with Open Collector Outputs)

REJ03D0397-0300

Rev.3.00

Jul.13.2005

Features

- Ordering Information

• HD74LS11

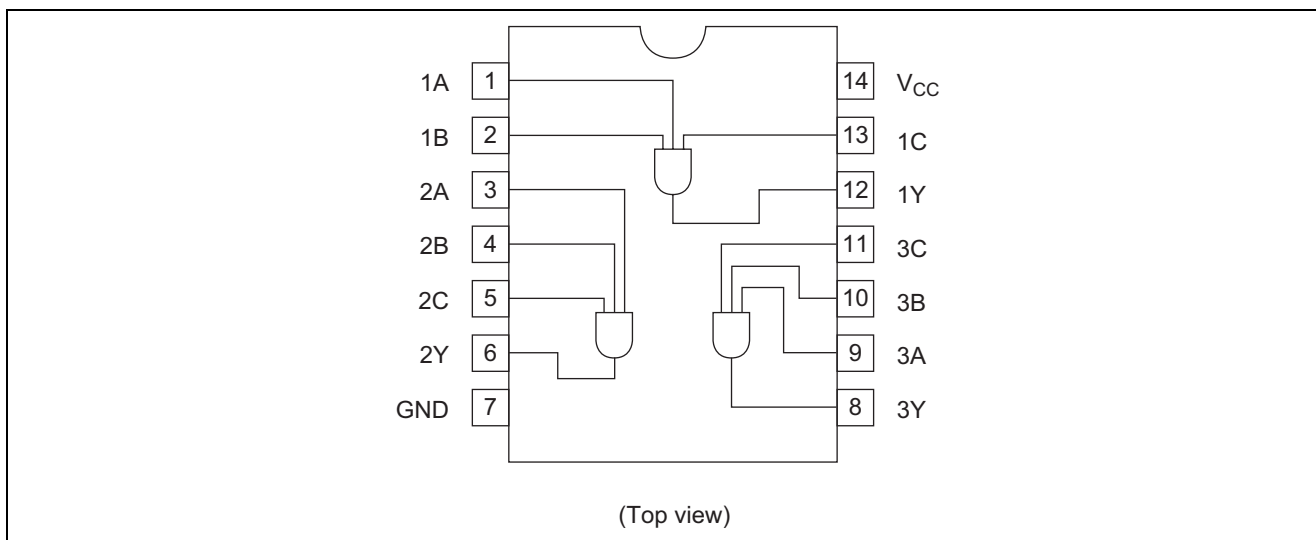
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS11P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	P	—
HD74LS11FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

• HD74LS15

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS15FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

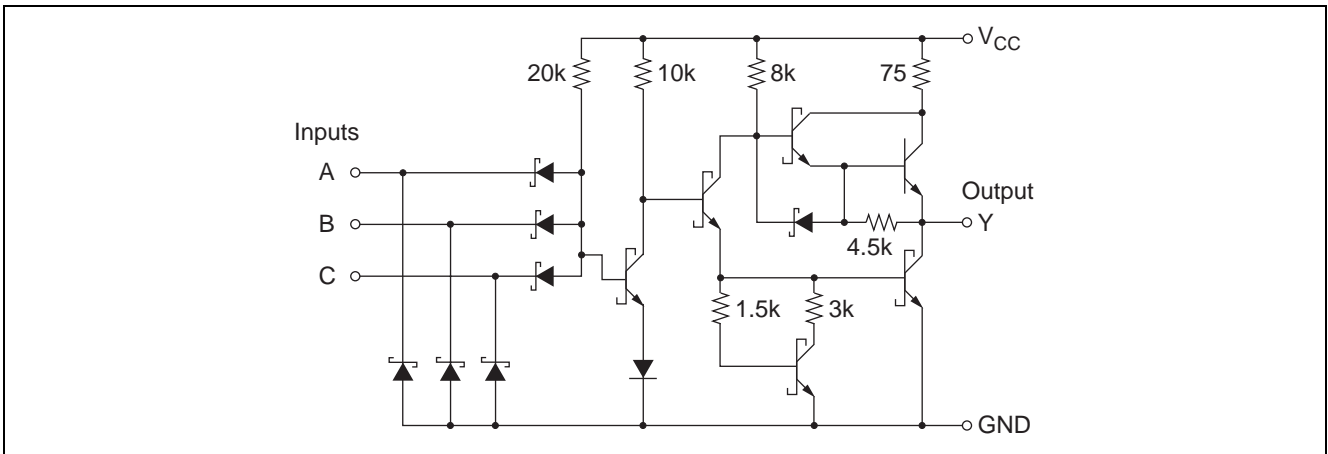
Note: Please consult the sales office for the above package availability.

Pin Arrangement

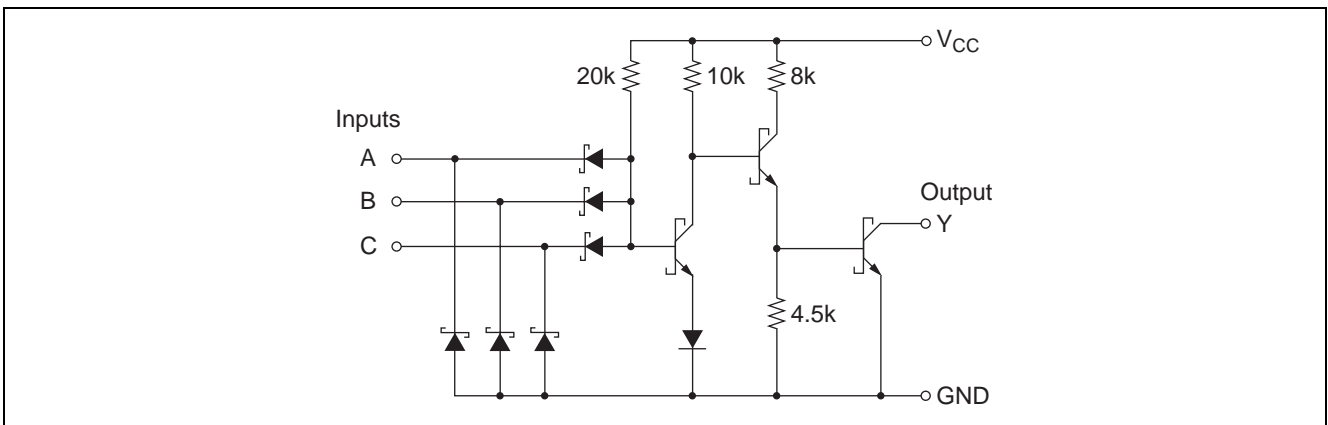


Circuit Schematic (1/3)

HD74LS11



HD74LS15



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC} ^{Note}	7	V
Input voltage	V_{IN}	7	V
Power dissipation	P_T	400	mW
Storage temperature	T_{stg}	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

• HD74LS11

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.75	5.00	5.25	V
Output current	I_{OH}	—	—	-400	μA
	I_{OL}	—	—	8	mA
Operating temperature	T_{opr}	-20	25	75	$^{\circ}C$

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Item	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.75	5.00	5.25	V
Output voltage	V_{OH}	—	—	5.5	V
Output current	I_{OL}	—	—	8	mA
Operating temperature	T_{opr}	-20	25	75	$^{\circ}C$

Electrical Characteristics

• HD74LS11

($T_a = -20$ to $+75^{\circ}C$)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V_{IH}	2.0	—	—	V	
	V_{IL}	—	—	0.8	V	
Output voltage	V_{OH}	2.7	—	—	V	$V_{CC} = 4.75$ V, $V_{IL} = 2$ V, $I_{OH} = -400$ μA
	V_{OL}	—	—	0.5	V	$V_{CC} = 4.75$ V, $V_{IH} = 0.8$ V
		—	—	0.4		
Input current	I_{IH}	—	—	20	μA	$V_{CC} = 5.25$ V, $V_I = 2.7$ V
	I_{IL}	—	—	-0.4	mA	$V_{CC} = 5.25$ V, $V_I = 0.4$ V
	I_I	—	—	0.1	mA	$V_{CC} = 5.25$ V, $V_I = 7$ V
Short-circuit output current	I_{OS}	-20	—	-100	mA	$V_{CC} = 5.25$ V
Supply current	I_{CCH}	—	1.8	3.6	mA	$V_{CC} = 5.25$ V
	I_{CCL}	—	3.3	6.6	mA	$V_{CC} = 5.25$ V
Input clamp voltage	V_{IK}	—	—	-1.5	V	$V_{CC} = 4.75$ V, $I_{IN} = -18$ mA

Note: * $V_{CC} = 5$ V, $T_a = 25^{\circ}C$

• HD74LS15

($T_a = -20$ to $+75^{\circ}C$)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V_{IH}	2.0	—	—	V	
	V_{IL}	—	—	0.8	V	
Output voltage	V_{OL}	—	—	0.5	V	$V_{CC} = 4.75$ V, $V_{IH} = 0.8$ V
		—	—	0.4		
Input current	I_{IH}	—	—	20	μA	$V_{CC} = 5.25$ V, $V_I = 2.7$ V
	I_{IL}	—	—	-0.4	mA	$V_{CC} = 5.25$ V, $V_I = 0.4$ V
	I_I	—	—	0.1	mA	$V_{CC} = 5.25$ V, $V_I = 7$ V
Output current	I_{OH}	—	—	100	μA	$V_{CC} = 4.75$ V, $V_{OH} = 5.5$ V
Supply current	I_{CCH}	—	1.8	3.6	mA	$V_{CC} = 5.25$ V
	I_{CCL}	—	3.3	6.6	mA	$V_{CC} = 5.25$ V
Input clamp voltage	V_{IK}	—	—	-1.5	V	$V_{CC} = 4.75$ V, $I_{IN} = -18$ mA

Note: * $V_{CC} = 5$ V, $T_a = 25^{\circ}C$

Switching Characteristics

• HD74LS11

($V_{CC} = 5\text{ V}$, $T_a = 25^\circ\text{C}$)

Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t_{PLH}	—	8	15	ns	$C_L = 15\text{ pF}$, $R_L = 2\text{ k}\Omega$
	t_{PHL}	—	10	20	ns	

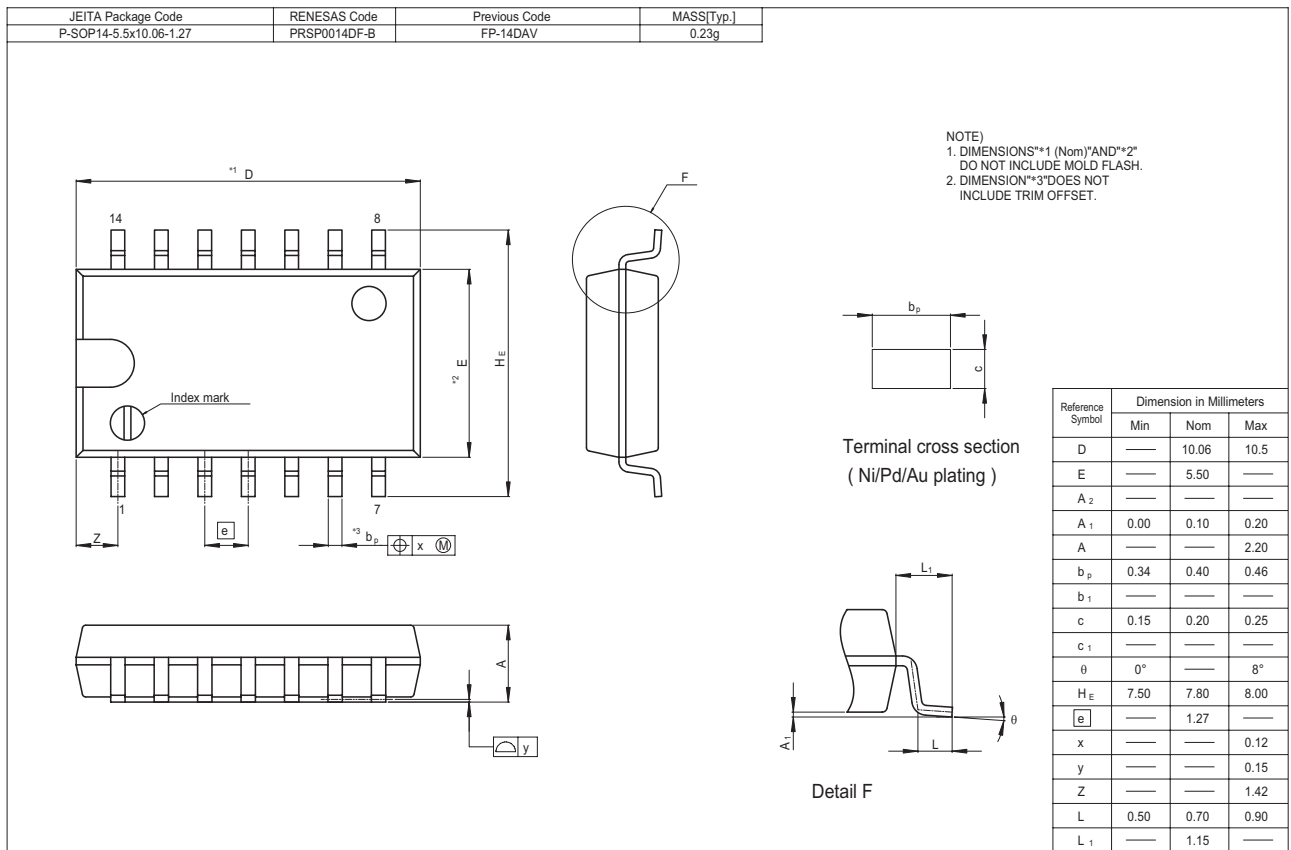
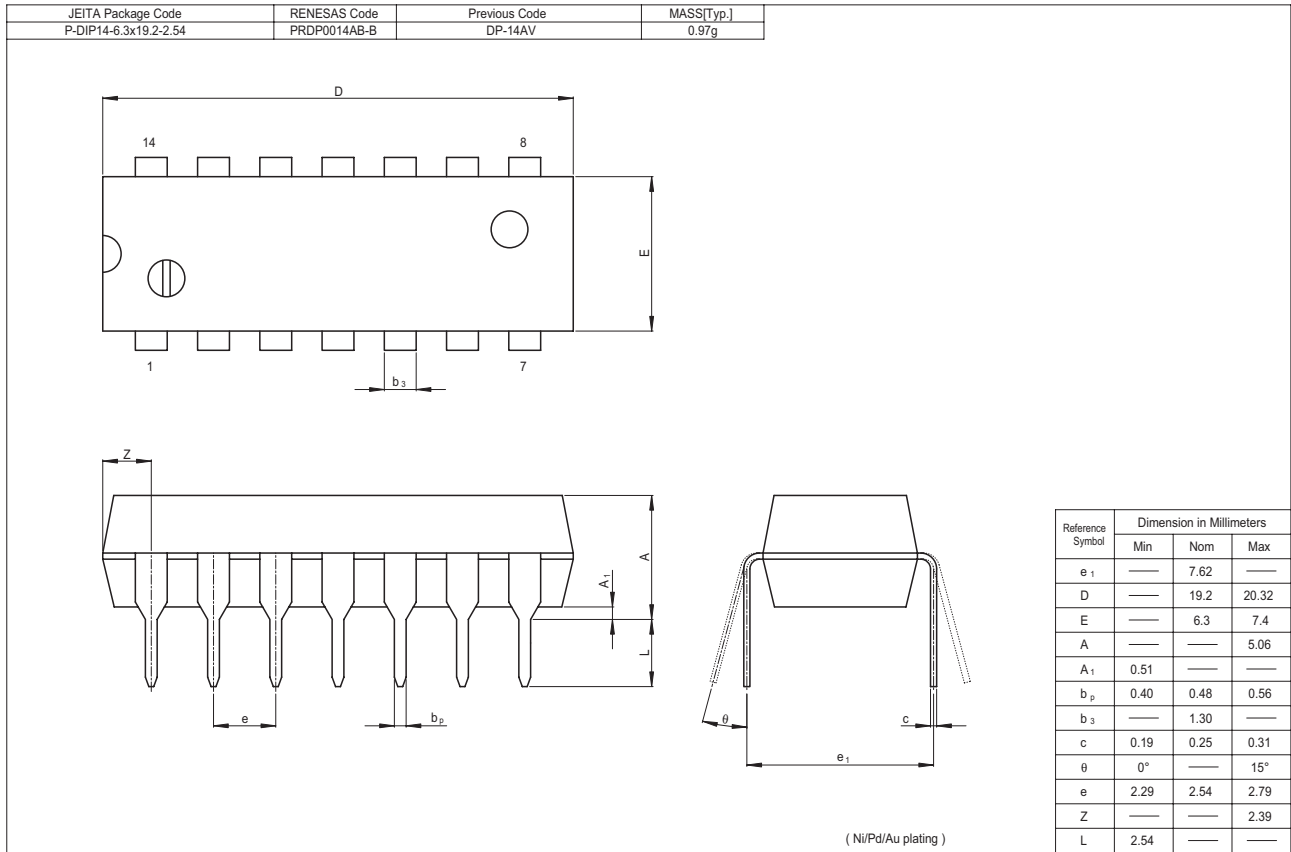
• HD74LS15

($V_{CC} = 5\text{ V}$, $T_a = 25^\circ\text{C}$)

Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t_{PLH}	—	20	35	ns	$C_L = 15\text{ pF}$, $R_L = 2\text{ k}\Omega$
	t_{PHL}	—	17	35	ns	

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

Package Dimensions



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450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.

10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.

Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea
Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

Renesas Technology Malaysia Sdn. Bhd.

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510